

1.6X0.8mm INFRARED EMITTING DIODE

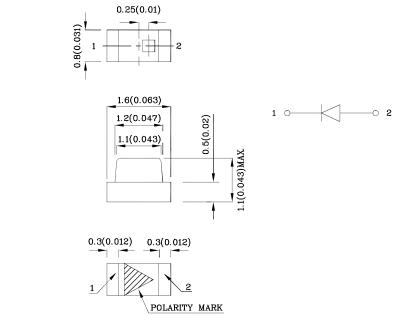
#### **Features**

- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- $\bullet$  MSL (Moisture Sensitivity Level): 3
- ullet RoHS compliant





## Package Schematics



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		THI (GaAlAs)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$I_{\mathrm{F}}$	50	mA	
Forward Current (Peak) 1/100 Duty Cycle 10us Pulse Width	$i_{\mathrm{FS}}$	1200	mA	
Power Dissipation	$P_{D}$	80	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		

Operating Characteristics (T <sub>A</sub> =25°C)	THI (GaAlAs)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	1.6	V
Reverse Current (Max.) $(V_R=5V)$	$I_{ m R}$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) $(I_F=20\text{mA})$	λΡ	880*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	50	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	90	pF

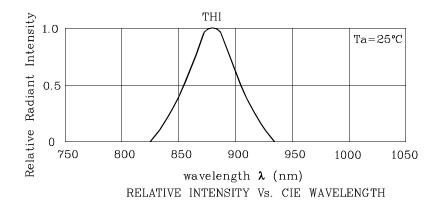
Part Number	Emitting Material	Lens-color	Radiant Intensity CIE127-2007* (Po=mW/sr) @20mA		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
			min.	typ.		
XZTHI53W	GaAlAs	Water Clear	0.8*	1.3*	880*	120°

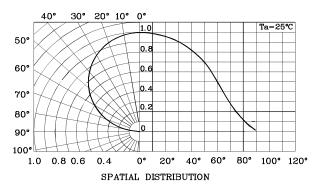
<sup>\*</sup>Radiant intensity value and wavelength are in accordance with CIE127-2007 standards.

Feb 25,2014 XDSA1793 V9-Z Layout: Maggie L.

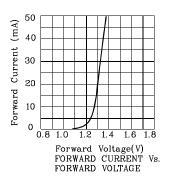


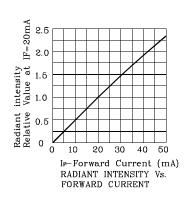


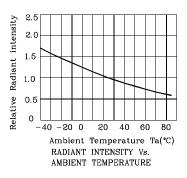




#### **♦** THI

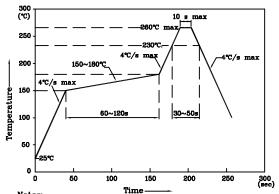






# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

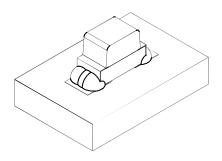


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

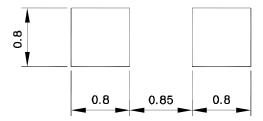




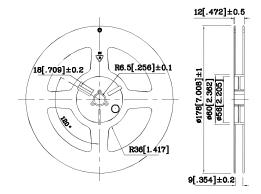
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



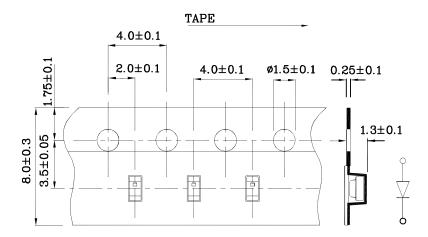
**❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



#### **❖** Reel Dimension



### **❖** Tape Specification (Units:mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage or radiant intensity / luminous flux), the typical accuracy of the sorting process is as follows:

- 1. Radiant Intensity / Luminous Flux: +/-15%
- 2. Forward Voltage: +/-0.1V

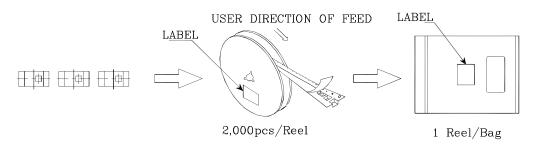
Note: Accuracy may depend on the sorting parameters

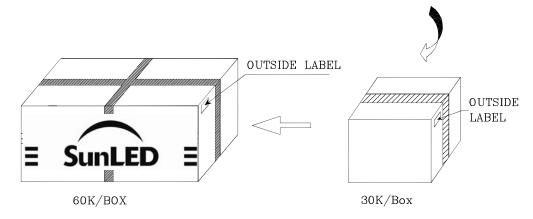
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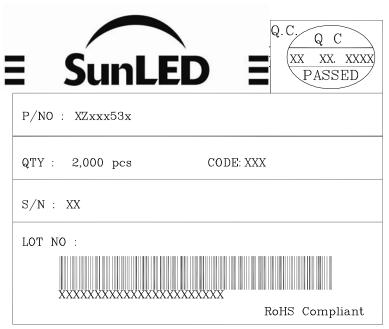




#### PACKING & LABEL SPECIFICATIONS







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